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To the Honorable Com

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the attached original documents or copy thereof.

1. Name of conveying party(ies):  
**Takaji SUMI, Osamu YAMAZAKI,  
Takashi SUGINO and Hideo SENOO**

2. Name and address of receiving party(ies)  
Name: **LINTEC CORPORATION**

Internal Address: \_\_\_\_\_

Additional name(s) of conveying party(ies) attached?  Yes  No

3. Nature of conveyance:  
 Assignment  Merger  
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Tokyo 173-0001, Japan**

City: \_\_\_\_\_ State: \_\_\_\_\_ Zip: \_\_\_\_\_

Execution Date: **February 3, 2004**

Additional name(s) & address(es) attached?  Yes  No

4. Application number(s) or patent number(s): **101487531**  
If this document is being filed together with a new application, the execution date of the application is: **February 3, 2004**  
A. Patent Application No.(s)  
B. Patent No.(s)

Additional numbers attached?  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:

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6. Total number of applications and patents involved: **1**

7. Total fee (37 CFR 3.41)..... \$ **40.00**

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8. Deposit account number:

**23-0650**

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*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*

**Kent E. Baldauf, Reg. No. 25,826**  
Name of Person Signing

**February 23, 2004**  
Date

Total number of pages including cover sheet, attachments, and documents: **2**

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PATENT  
REEL: 015638 FRAME: 0987

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02/23/04  
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**ASSIGNMENT**

WHEREAS, WE, 1) SUMI, Takaji, 2) YAMAZAKI, Osamu, 3) SUGINO, Takashi & 4) SENOO, Hideo  
residing in 1) 43-7, Yamato-cho, Itabashi-ku, Tokyo 173-0012, Japan,  
2) 7-7-3, Tsuji, Saitama-shi, Saitama 336-0026, Japan, \*\*\*  
respectively, have invented certain new and useful improvements in the invention entitled  
ADHESIVE TAPE for  
which a patent application was filed in the United States Patent and Trademark Office on  
and bears Serial No.

AND, LINTEC CORPORATION, a corporation  
of Japan, having a place of business at 23-23, Honcho, Itabashi-ku, Tokyo 173-0001, Japan  
hereinafter called the "assignee", is desirous of acquiring the entire right, title, and interest in and  
to said application and the inventions and improvements therein disclosed.

NOW, THEREFORE, for good and valuable consideration paid to us by said  
assignee, the receipt of which is hereby acknowledged, we do hereby assign, sell, transfer, and  
set over unto said assignee the entire right, title and interest in and to said application and the  
inventions and improvements therein disclosed for the United States and all foreign countries and  
any Letters Patent which may issue therefor in the United States and all foreign countries and all  
divisions, reissues, continuations, continuations-in-part, renewals, and/or extensions thereof, said  
assignee to have and to hold the interests herein assigned to the full ends of the terms of said  
Letters Patent and any and all divisions, reissues, continuations, continuations-in-part, renewals,  
and/or extensions thereof, respectively, as fully and entirely as the same would have been held  
and enjoyed by us had this assignment not been made.

The Commissioner for Patents is requested to issue such Letters Patent in  
accordance herewith. We covenant that we are the lawful owners of the said application,  
inventions, and improvements, that the same are unencumbered, that no license has been granted  
to make, use, or vend the said inventions or improvements or any of them, and that we have the  
full right to make this assignment.

And for the consideration aforesaid, we agree jointly and individually that we will  
communicate to said assignee or the representatives thereof any facts known to us respecting said  
inventions and improvements, and will, upon request, but without expense to us, testify in any  
legal proceedings, sign all lawful papers, execute all divisional, reissue, continuation,  
continuation-in-part, renewal, and/or extension applications, make all rightful oaths, and  
generally do all other and further lawful acts, deemed necessary or expedient by said assignee or  
by counsel for said assignee, to assist or enable said assignee to obtain and enforce full benefits  
from the rights and interests herein assigned. This assignment shall be binding upon our heirs,  
executors, administrators, and/or assigns, and shall inure to the benefit of the heirs, executors,  
administrators, successors, and/or assigns, as the case may be, of said assignee.

Date Feb. 3, 2004 Inventor T. Sumi  
Date Feb. 3, 2004 Inventor Osamu Yamazaki  
Date Feb. 3, 2004 Inventor Takashi Sugino  
Date Feb. 3, 2004 Inventor Hideo Senoo

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4) 3-33-2, Totsuka, Kawaguchi-shi, Saitama 333-0811, Japan